



DMT4002LPS

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> T <sub>C</sub> = +25°C (Note 9)
40V	$1.8m\Omega @ V_{GS} = 10V$	100A
	$3.1 \text{m}\Omega @ V_{\text{GS}} = 4.5 \text{V}$	100A

## **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Engine Management Systems
- **Body Control Electronics**
- **DC-DC Converters**

PowerDI5060-8 (Type K)





Top View



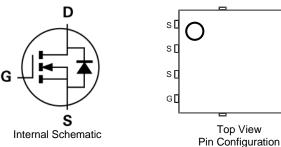
## 40V N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI

### **Features**

- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Thermally Efficient Package-Cooler Running Applications
- **High Conversion Efficiency** .
- Low R<sub>DS(ON)</sub> Minimizes On State Losses
- <1.1mm Package Profile Ideal for Thin Applications •
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### Mechanical Data

- Case: PowerDI5060-8 (Type K) •
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



### Ordering Information (Note 4)

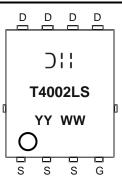
	Part Number	Case	Packaging		
	DMT4002LPS-13	PowerDI5060-8 (Type K)	2,500 / Tape & Reel		
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"					

and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



 $\Box$  = Manufacturer's Marking T4002LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 = 2016) WW = Week Code (01 to 53)

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# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage	V <sub>DSS</sub>	40	V	
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Notes 6, 9)	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	I <sub>D</sub>	100 100	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I <sub>DM</sub>	200	А
Continuous Body Diode Forward Current (Note 6)	T <sub>C</sub> = +25°C	Is	85	А
Avalanche Current, L = 0.1mH		I <sub>AS</sub>	48	А
Avalanche Energy, L = 0.1mH		E <sub>AS</sub>	115	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	55	°C/W
Total Power Dissipation (Note 6)	PD	104	W
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	1.2	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	С°

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	I I						
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						-	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	_	1	μA	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		—	1.3	1.8	mΩ	$V_{GS} = 10V, I_D = 25A$	
	R <sub>DS(ON)</sub>	—	2	3.1	11152	$V_{GS} = 4.5V, I_D = 25A$	
Diode Forward Voltage	V <sub>SD</sub>	—	—	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>		6771			$V_{DS} = 20V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	C <sub>oss</sub>	—	2165	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	—	176				
Gate Resistance	R <sub>G</sub>	—	0.85	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	—	116.1	-		$V_{DD}$ = 20V, $I_D$ = 25A, $V_{GS}$ = 10V	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	55.2	_	nC		
Gate-Source Charge	Q <sub>gs</sub>	_	20.3	_	nc		
Gate-Drain Charge	Q <sub>gd</sub>	_	22.7				
Turn-On Delay Time	t <sub>D(ON)</sub>	_	11.4	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_D = 25A, R_G = 3\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	22.9				
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	62.5		ns		
Turn-Off Fall Time	t <sub>F</sub>	_	28		]		
Reverse Recovery Time	t <sub>RR</sub>	_	58.6		ns		
Reverse Recovery Charge	Q <sub>RR</sub>	_	107	_	nC	I <sub>F</sub> = 25A, di/dt = 100A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad).

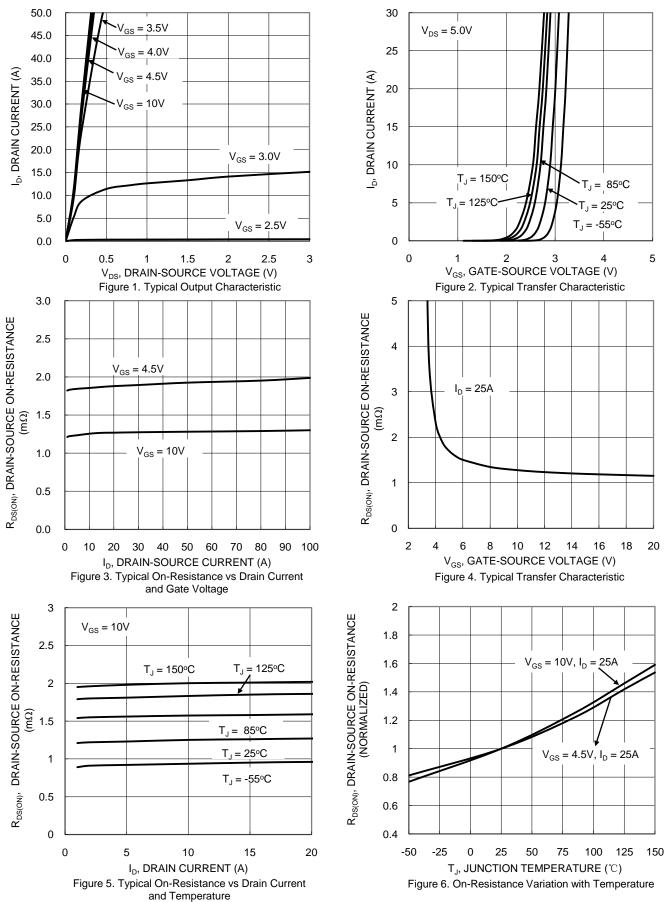
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

9. Package limited.



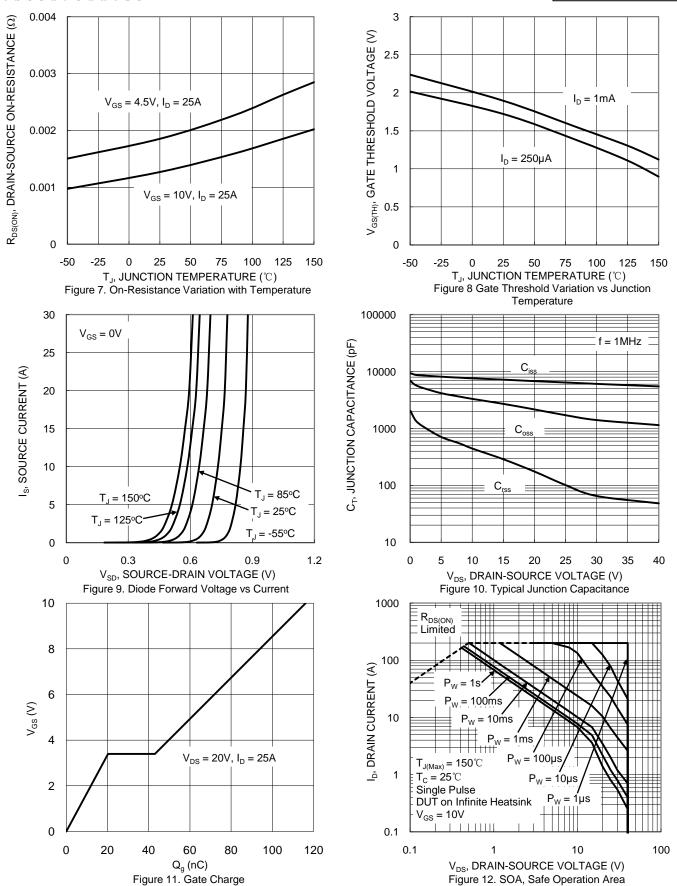
## DMT4002LPS



PowerDI is a registered trademark of Diodes Incorporated. DMT4002LPS Document number: DS38972 Rev. 2 - 2

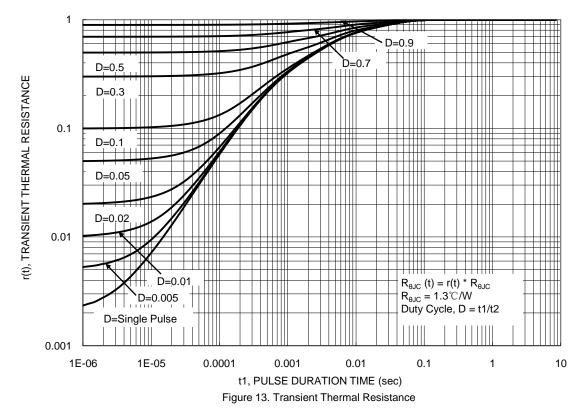


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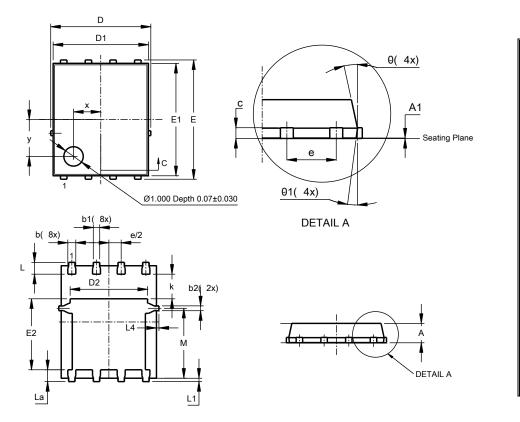




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8 (Type K)

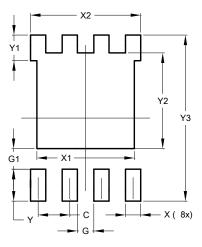


PowerDI5060-8 (Type K)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	0.02		
b	0.33	0.51	0.41		
b1	0.300	0.366	0.333		
b2	0.20	0.35	0.25		
С	0.23	0.33	0.277		
D	5	.15 BS0	0		
D1	4.85	4.95	4.90		
D2	-	- 3.9			
E	6	.15 BS0	0		
E1	5.75	5.85	5.80		
E2	3.56	3.725	3.66		
E	1	.27BSC	)		
k	-	-	1.27		
L	0.51	0.71	0.61		
La	0.51	0.675	0.61		
L1	0.05	0.20	0.175		
L4	-	-	0.125		
Μ	3.50	3.71	3.605		
х	-	-	1.400		
у	-	-	1.900		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All	All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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